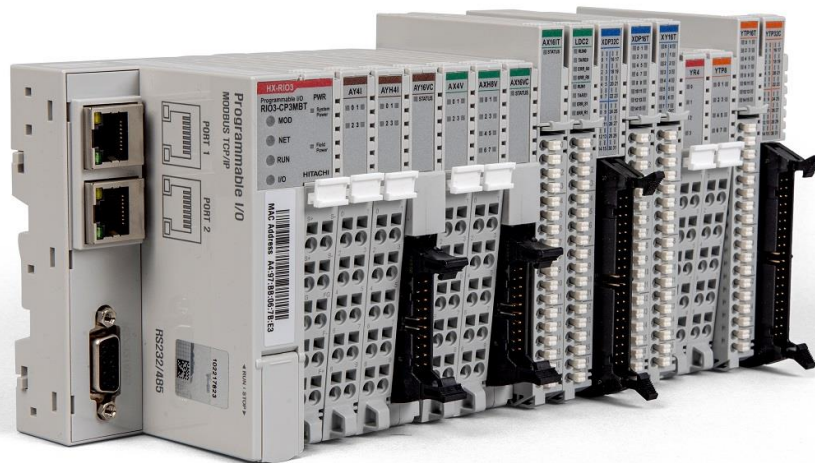


Special I/O Module

RIO3-LDC2 User Manual



REVISION HISTORY				
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1. Important Notes

Solid state equipment has operational characteristics differing from those of electromechanical equipment.

Safety Guidelines for the Application, Installation and Maintenance of Solid-State Controls describes some important differences between solid state equipment and hard-wired electromechanical devices.

Because of this difference, and because of the wide variety of uses for solid state equipment, all persons responsible for applying this equipment must satisfy themselves that each intended application of this equipment is acceptable.

In no event will HITACHI be responsible or liable for indirect or consequential damages resulting from the use or application of this equipment.

The examples and diagrams in this manual are included solely for illustrative purposes. Because of the many variables and requirements associated with any installation, HITACHI cannot assume responsibility or liability for actual use based on the examples and diagrams.

Warning!



- ✓ **If you don't follow the directions, it could cause a personal injury, damage to the equipment or explosion**
- ✓ Do not assemble the products and wire with power applied to the system. Else it may cause an electric arc, which can result into unexpected and potentially dangerous action by field devices. Arching is explosion risk in hazardous locations. Be sure that the area is non-hazardous or remove system power appropriately before assembling or wiring the modules.
- ✓ Do not touch any terminal blocks or IO modules when system is running. Else it may cause the unit to an electric shock or malfunction.
- ✓ Keep away from the strange metallic materials not related to the unit and wiring works should be controlled by the electric expert engineer. Else it may cause the unit to a fire, electric shock or malfunction.

Caution!


- ✓ **If you disobey the instructions, there may be possibility of personal injury, damage to equipment or explosion. Please follow below Instructions.**
- ✓ Check the rated voltage and terminal array before wiring. Avoid the circumstances over 50°C of temperature. Avoid placing it directly in the sunlight.
- ✓ Avoid the place under circumstances over 85% of humidity.
- ✓ Do not place Modules near by the inflammable material. Else it may cause a fire.
- ✓ Do not permit any vibration approaching it directly.
- ✓ Go through module specification carefully, ensure inputs, output connections are made with the specifications. Use standard cables for wiring.
- ✓ Use Product under pollution degree 2 environment.

1.1. Safety Instruction

1.1.1. Symbols

<p>DANGER</p> 	<p>Identifies information about practices or circumstances that can cause an explosion in a hazardous environment, which may lead to personal injury or death property damage, or economic loss.</p>
<p>IMPORTANT</p>	<p>Identifies information that is critical for successful application and understanding of the product</p>
<p>ATTENTION</p> 	<p>Identifies information about practices or circumstances that can lead to personal injury, property damage, or economic loss. Attentions help you to identify a hazard, avoid a hazard, and recognize the consequences.</p>

1.1.2. Safety Notes

<p>DANGER</p> 	<p>The modules are equipped with electronic components that may be destroyed by electrostatic discharge. When handling the modules, ensure that the environment (persons, workplace and packing) is well grounded. Avoid touching conductive components, G-BUS Pin.</p>
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1.1.3. Certification

UL Listed Industrial Control Equipment, certified for U.S.

See UL File E196687

CE Certificate

EN 61000-6-2; Industrial Immunity

EN 61000-6-4; Industrial Emissions

Reach, RoHS (EU, CHINA), EAC

2. RIO3-LDC2 (2ch load cell input unit, strain gauge)

2.1. RIO3-LDC2 Specification

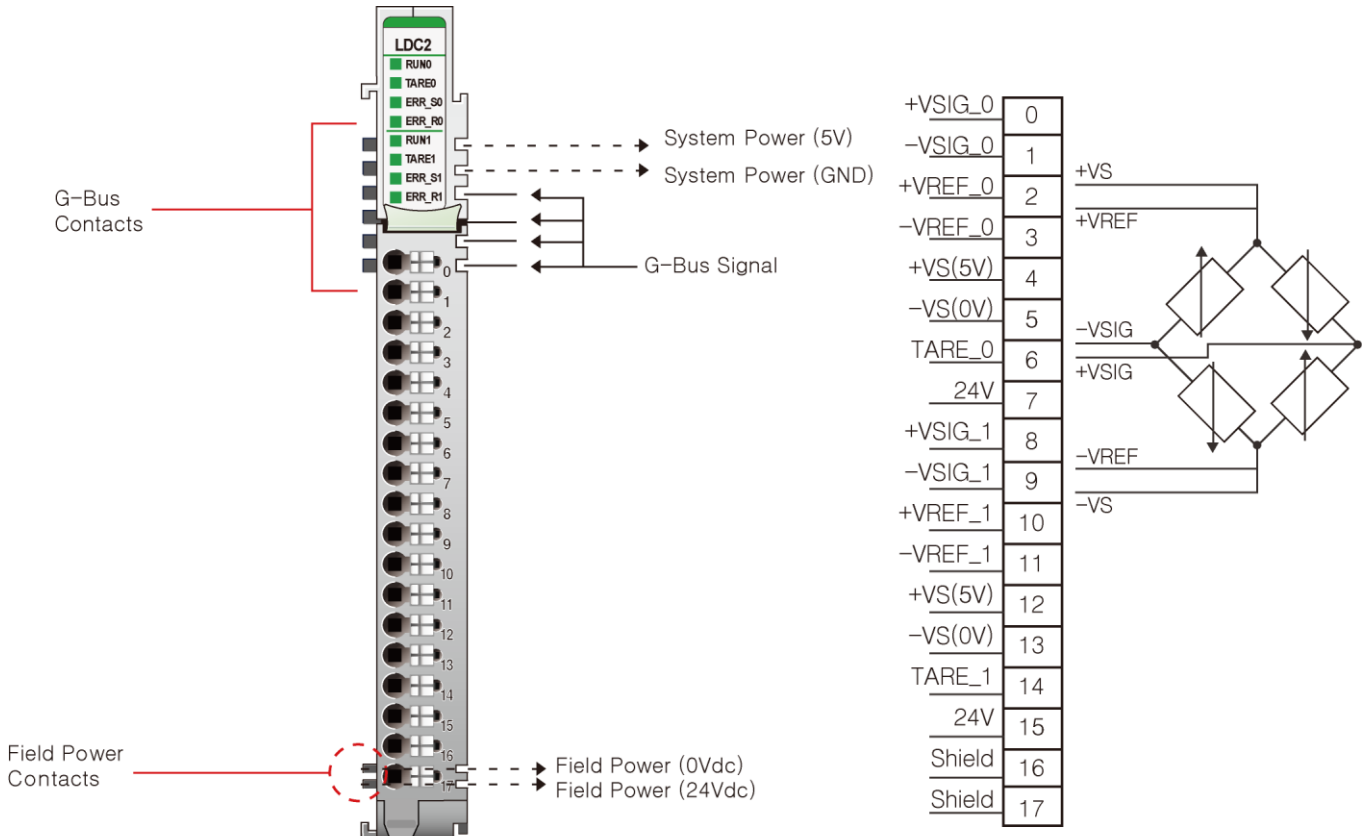
Items	Specification
Resistor bridge input specification	
Number of channels	2 channels, Strain gauge input
Input type	Resistor bridge, Strain gauge
Indicators	Run 0,1 / Tare 0,1 Error_Sig.voltage 0,1 / Error_Ref.voltage 0,1 8 Green LED
Input range VSEN	-150mV ~ +150mV
Input range VREF	0 ~10V
Internal resistance	> 1 MΩ (VSEN, VREF)
Measuring error	< ±0.1% Full Scale @ 25°C ambient < ±0.3% Full Scale @ -40 ~ 60°C ambient
Resolution	24bit, 32bit presentation
Conversion time	Max. 500us
Filter	Max. 64 samples filtering, parameterizable
Special features	Open load check, Tare, 5VDC bridge supply
Bridge supply specification (Power)	
Voltage source	5V dc nominal **
Current rate	Max. 30mA
Digital input specification (Tare input)	
On-state voltage	24V dc nominal
Internal resistance	11.4k ohm
General specification	
Power dissipation	Max. 25mA @ 5Vdc
Isolation	I/O to Logic : Photocoupler Isolation Field power : Non-Isolation
UL Field Power	Supply Voltage : 24Vdc nominal, Class 2
Field Power	Supply Voltage : 24Vdc nominal Voltage Range : 18~30Vdc Power Dissipation : Max. 25mA @ 24Vdc
Single Wiring	I/O Cable Max. 0.75mm ² (AWG 18)
Weight	63g
Module Size	12mm x 109mm x 70mm
Environment Condition	Refer to 'Environment Specification'

* Load cell signals have low voltage levels and are very sensitive to external noise. Therefore, EMC protection may be necessary depending on the system environment.

- It is recommended to install GT-7151/GT-7851 according to the system environment.

** Voltage drop occurs depending on the specifications of the cable and load of the voltage source.(Max 0.7V)

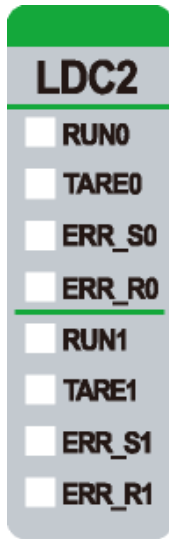
2.2. RIO3-LDC2 Wiring Diagram



Pin No.	Signal Description
0	Bridge signal input voltage + #0
1	Bridge signal input voltage - #0
2	Bridge reference input voltage + #0
3	Bridge reference input voltage + #0
4	+5V(bridge supply)
5	0V(bridge supply)
6	Tare input(24V) #0
7	Field power(24V)
8	Bridge signal input voltage + #1
9	Bridge signal input voltage - #1
10	Bridge reference input voltage + #1
11	Bridge reference input voltage + #1
12	+5V(bridge supply)
13	0V(bridge supply)
14	Tare input(24V) #1
15	Field power(24V)
16	Shield
17	Shield

2.3. RIO3-LDC2 LED Indicator

2.3.1. LED Indicator



LED No.	LED Function / Description	LED Color
0	Run #0	Green
1	Tare #0	Green
2	Error signal voltage #0	Green
3	Error reference voltage #0	Green
4	Run #1	Green
5	Tare #1	Green
6	Error signal voltage #1	Green
7	Error reference voltage #1	Green

2.3.2 Channel Status LED

LED Function	LED	To Indicate
Run	Off	G-bus fault / Not power supply
	On	Normal operation
Tare	Off	Taring calibration off (H/W or S/W)
	On	Taring calibration on (H/W or S/W)
Error signal voltage	Off	Normal operation
	On	Bridge signal input voltage range over / Open load
Error reference voltage	Off	Normal operation
	On	Bridge reference input voltage range over

2.4. Mapping data from the image table

- **Input Image Value - 16Byte**

Bit No	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
Byte 0	#0 Bridge input byte LL							
Byte 1	#0 Bridge input byte LH							
Byte 2	#0 Bridge input byte HL							
Byte 3	#0 Bridge input byte HH							
Byte 4	#0 Reference input byte LL							
Byte 5	#0 Reference input byte LH							
Byte 6	#0 Reference input byte HL							
Byte 7	#0 Reference input byte HH							
Byte 8	#1 Bridge input byte LL							
Byte 9	#1 Bridge input byte LH							
Byte 10	#1 Bridge input byte HL							
Byte 11	#1 Bridge input byte HH							
Byte 12	#1 Reference input byte LL							
Byte 13	#1 Reference input byte LH							
Byte 14	#1 Reference input byte HL							
Byte 15	#1 Reference input byte HH							

* Field power off(Input data) : FFFF FFFF FFFF FFFF FFFF FFFF FFFF

- **Output Image Value - 2Byte**

Bit No	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
Byte 0	-	-	-	-	-	-	SWT1	SWT0
Byte 1	Reserved							

- SWT0,1 : S/W Taring bit(#0, #1)

- Reserved : Not used

2.5. Parameter Data

- **Valid Parameter length : 2 Bytes**

- **Parameter Data**

Bit No	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	
Byte 0								Sampling filter	
Byte 1	Reserved								

- Sampling filter

000 : 32 sampling(default)

001 : 2 sampling

010 : 4 sampling

011 : 8 sampling

100 : 16 sampling

101 : 32 sampling

110 : 64 sampling

3. Application : Load cell

Calculating the weight

The sensor receives the analog signal and calculates the weight.

$$G = (U_{SIG} / U_{REF}) * (L_{R.O.} / L_{R.C.}) \quad G : \text{Weight value (kg)}$$

$$U_{SIG} = V_{SIG} (\text{dec}) * (150\text{mV} / 8388607), \text{ Unit : [mV]}$$

- Max. V_{SIG} value : 150mV, 0x7FFFFFFF = 8388607 (dec)

$$U_{REF} = V_{REF} (\text{dec}) * (10\text{V} / 8388607), \text{ Unit : [V]}$$

- Max. V_{REF} value : 10V, 0x7FFFFFFF = 8388607 (dec)

Symbol	Meaning	Unit
U_{SIG}	Signal voltage from the load cell	mV
U_{REF}	Reference voltage from the load cell	V
V_{SIG}	Bridge signal input voltage	1
V_{REF}	Bridge reference input voltage	1
$L_{R.C.}$	Rated capacity of the load cell	1mV/V
$L_{R.O.}$	Rated output of the load cell	kg

Example

1) Load cell sensor technical data

- Rated capacity : 2mV/V ($L_{R.C.}$)
- Rated output(max load) : 100kg ($L_{R.O.}$)
- Supply voltage : 5V

2) Calculating the weight

- V_{SIG} value : 0x000660AF (dec 417967)

$$U_{SIG} = 417967 * (150\text{mV} / 8388607) = 7.473833\text{mV}$$

- V_{REF} value : 0x003F6E23 (dec 4156963)

$$U_{REF} = 4156963 * (10\text{V} / 8388607) = 4.955486\text{V}$$

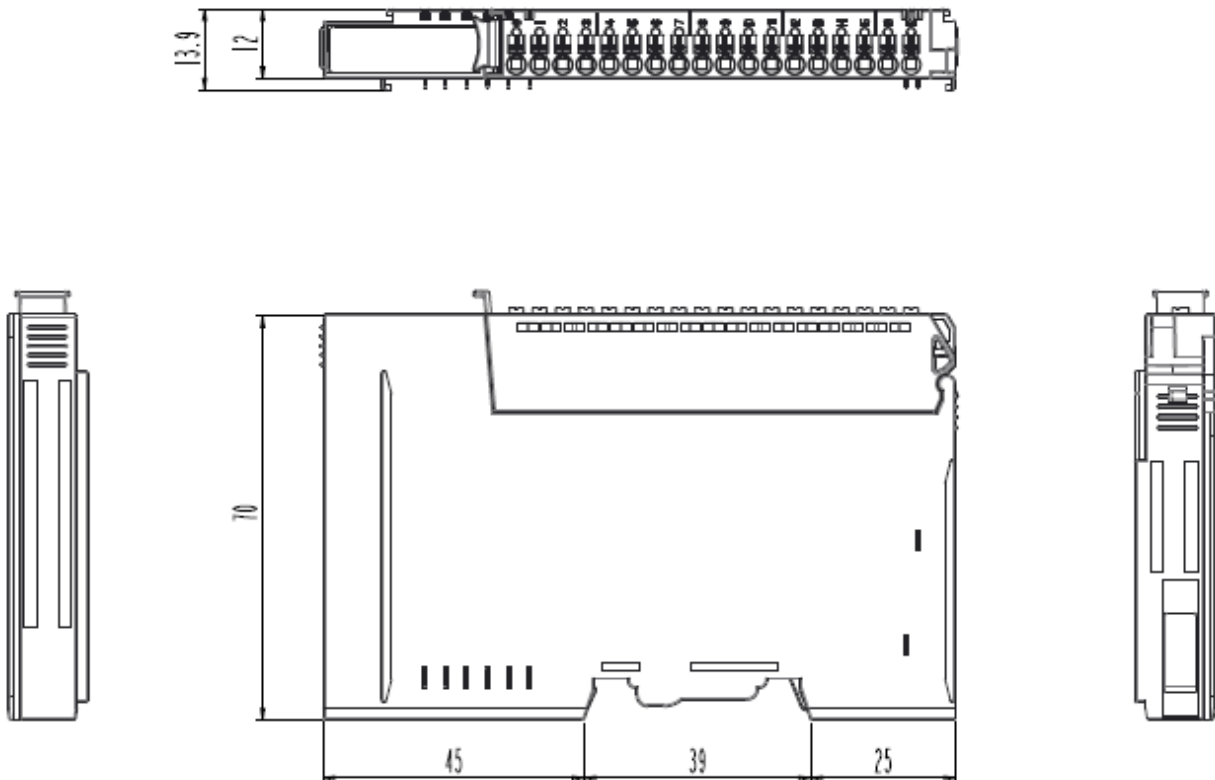
- $G = (7.473833\text{mV} / 4.955486\text{V}) * (100\text{kg} / 2\text{mV/V}) = 75.409687\text{kg}$

4. Environment Specification

Environmental specification	
Operating Temperature	-40°C ~ 60°C
UL Temperature	-20°C ~ 60°C
Storage Temperature	-40°C ~ 85°C
Relative Humidity	5%~90% non-condensing
Mounting	DIN rail
General specification	
Shock Operating	IEC 60068-2-27
Vibration Resistance	Based on IEC 60068-2-6 DNVGL-CG-0039: Vibration Class B, 4g
Industrial Emissions	EN61000-6-4/All: 2011
Industrial Immunity	EN61000-6-2: 2005
Installation Position	Vertical and horizontal installation is possible
Product Certifications	CE, UL, EAC

5. Dimension

5.1. RIO3-LDC2



Dimensions in mm

6. Mounting

Caution!

Hot surface!

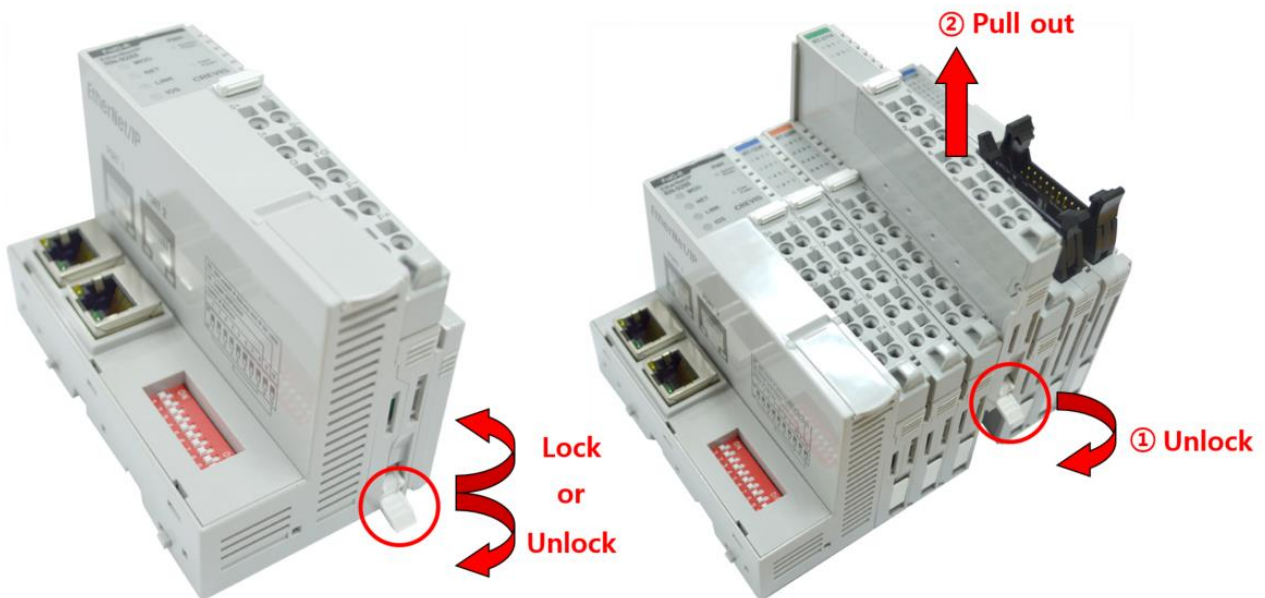
The surface of the housing can become hot during operation. If the device was operated at high ambient temperatures, allow it to cool off before touching it.

Notice!

Perform work on devices only if they are de-energized!

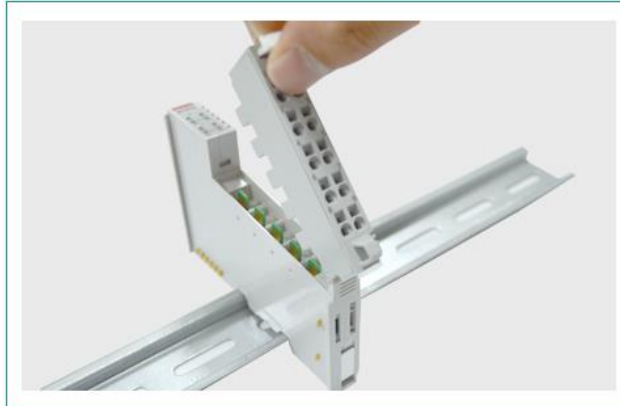
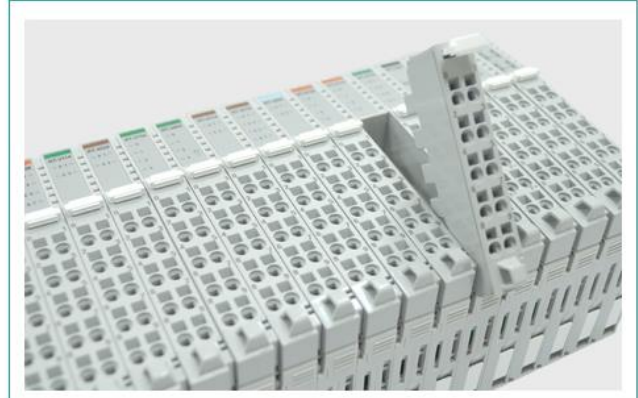
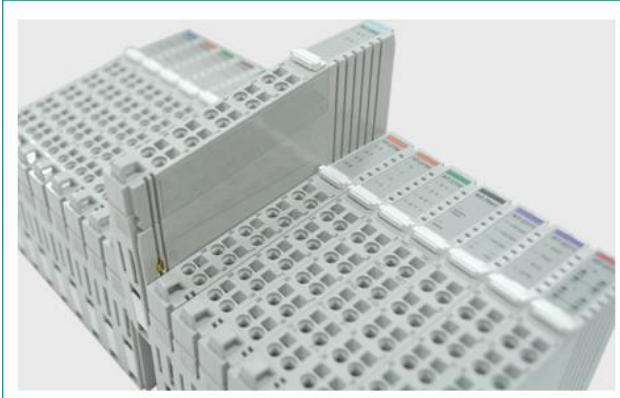
Working on energized devices can damage them. Therefore, turn off the power supply before working on the devices.

6.1. I/O Inserting and Removing Devices



As above figure in order to safeguard the RIO3-Module from jamming, it should be fixed onto the DIN rail with locking lever. To do so, fold on the upper of the locking lever. To pull out the RIO3-Module, unfold the locking lever as below figure.

6.2.RTB (Removable Terminal Block)



Whole terminal block can be combined and removed for the convenience if its maintenance.

There is a locking switch on the RTB for the easy combination and easy removal.

Easy combination and easy removal for IO modules on the din rail through One Touch Locking Switch.

7. G-Bus Pin Description

Communication between the Network Adapter and the expansion module as well as system / field power supply of the bus modules is carried out via the internal bus. It is comprised of 6 data pin and 2 field power pin.



*Please refer to the table below regarding the pin description from P1 to P8.

No.	Description
P1	Field Power (VCC)
P2	Field Power (GND)
P3	GBUS CLK
P4	GBUS MISO
P5	GBUS MOSI
P6	GBUS Token
P7	System Power (GND)
P8	System Power (VCC)

DANGER



Do not touch data and field power pins in order to avoid soiling and damage by ESD noise.

APPENDIX A

A.1. Product List

No.	RIO3-Number	Description	ID (hex)
Digital Input Module			
01	RIO3-XDP8	8 Points, Universal, 24Vdc, 10RTB	1238
02	RIO3-XDP16C	16 Points, Universal, 24Vdc, 20P connector	123F
03	RIO3-XDP16T	16 Points, Universal, 24Vdc, 18RTB	12DF
04	RIO3-XDP32C	32 Points, Universal, 24Vdc, 40P connector	12FA
05	RIO3-XY16T	8 Sink Input / 8 Source Output with Diagnostic, 24Vdc	1428
06	RIO3-XAH4	4 Points, 240Vac, 10RTB	1904
Digital Output Module			
07	RIO3-YTP8	8 Points, Source, 24Vdc/0.5A, 10RTB	2328
08	RIO3-YTP16C	16 Points, Source, 24Vdc/0.3A, 20P connector	222F
09	RIO3-YTP16T	16 Points, Source, 24Vdc/0.3A, 18RTB	226F
10	RIO3-YTP32C	32 Points, Source, 24Vdc/0.3A, 40P connector	22CA
11	RIO3-YS4	4 Points, MOS Relay, 240Vdc/ac, 0.5A, 10RTB	2734
12	RIO3-YS8	8 Points, MOS Relay Output Terminal, 240Vdc, 0.5A	2738
13	RIO3-YR4	4 Points, Relay, 24Vdc/2A, 240Vac/2A, 10RTB	2744
Analog Input Module			
14	RIO3-LDC2	2ch load cell input unit, strain gauge	3002
15	RIO3-AX4I	4 Channels, 0~20, 4~20mA, 12bits, 10RTB	3114
16	RIO3-AXH4I	4 Channels, 0~20, 4~20mA, 16bits, 10RTB	3154
17	RIO3-AX8I	8 Channels, 0~20, 4~20mA, 12bits, 10RTB	3118
18	RIO3-AXH8I	8 Channels, 0~20, 4~20mA, 16bits, 10RTB	3158
19	RIO3-AX16IC	16 Channels, 0~20, 4~20mA, 12bits, 20P connector	311F
20	RIO3-AX16IT	16 Channels, 0~20, 4~20mA, 12bits, 18RTB	317F
21	RIO3-AX4V	4 Channels, 0~10, 0~5, 1~5Vdc, 12bits, 10RTB	3424
22	RIO3-AXH4V	4 Channels, 0~10, 0~5, 1~5Vdc, 16bits, 10RTB	3464
23	RIO3-AX8V	8 Channels, 0~10, 0~5, 1~5Vdc, 12bits, 10RTB	3428
24	RIO3-AXH8V	8 Channels, 0~10, 0~5, 1~5Vdc, 16bits, 10RTB	3468
25	RIO3-AX16VC	16 Channels, 0~10, 0~5, 1~5Vdc, 12bits, 20P connector	342F
26	RIO3-AX16VT	16 Channels, 0~10, 0~5, 1~5Vdc, 12bits, 18RTB	347F
27	RIO3-RTD4T	4 Channels, RTD, 10RTB	3704
28	RIO3-RTD8C	8 Channels, RTD, 20P connector	3708
29	RIO3-TC4T	4 Channels, Thermocouple, 10RTB	3804
30	RIO3-E3AC	AC Measurement	3901
Analog Output Module			
31	RIO3-AY4I	4 Channels, Current Output, 4~20mA, 12bits	4214
32	RIO3-AYH4I	4 Channels, Current Output, 4~20mA, 16bits	4254
33	RIO3-AY8I	8 CHANNELS CURRENT OUTPUT, 4~20mA, 12BIT	4218
34	RIO3-AY4V	4CH, 0~10Vdc, 12Bits, 10RTB	4424
35	RIO3-AYH4V	4CH, 0~10Vdc, 16Bits, 10RTB	4464

36	RIO3-AY8V	8CH, 0~10Vdc, 12Bits, 10RTB	4428
37	RIO3-AY16VC	16CH, 0~10Vdc, 12Bits, 20P Connector	442F
38	RIO3-AY16VT	16CH, 0~10Vdc, 12Bits, 18RTB	447F
Special Module			
39	RIO3-CU24L	High Speed Counter, 2CHs, 24Vdc, Encoder Input, 10RTB	
40	RIO3-RS232	1CH, RS 232, RTS/CTS, Full Duplex Type, 10RTB	5211
41	RIO3-RS485	1CH, RS 485, Half Full Duplex Type, 10RTB	5231
42	RIO3-PWM2	PWM Output, 2CHs, 0.5A/24Vdc, Source, 18RTB	5442
43	RIO3-PO2	Pulse Output, 2CHs, 0.5A/24Vdc, Source, 18RTB	5642
Power Module			
44	RIO3-SHD	Shield Module	7408
45	RIO3-0VDC	Common for 0Vdc	7508
46	RIO3-PSD	Power Expansion, In 24Vdc, Out 1A/5Vdc	7511
47	RIO3-24VDC	Common for 24Vdc	7518
48	RIO3-VDC	Common for 0Vdc, 24Vdc	7588
49	RIO3-PS	Field Power, 5/24/48 Vdc, 110/220 Vac	7641

A.2. Glossary

System Power: The power for starting up CPU.

Field Power: The power for input and output line.

Terminator Resistor: Resistor for prevention reflected wave.

EDS: Electronic Data Sheet.

Sink: The method of in/output power supply if a device has no power source.

Source: The method of in/output power supply if a device has the power source.